

L Number	Hits	Search Text	DB	Time stamp
1	0	5184768.pn	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 16:27
2	2	5184768.pn.	USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 16:33
3	890	((quadrilateral quadri quadrilaterally) with (pad terminal electrode contact))	USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 16:39
4	232370	((xray (x adj ray)))	USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 16:35
5	27	((xray (x adj ray))) and ((quadrilateral quadri quadrilaterally) with (pad terminal electrode contact))	USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 16:35
6	46981	((square) with (pad terminal electrode contact))	USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 16:40
7	1973	((xray (x adj ray))) and ((square) with (pad terminal electrode contact))	USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 16:40
8	137	((xray (x adj ray))) same ((square) with (pad terminal electrode contact))	USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 16:40

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1	232370	xray (x adj ray)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 12:22
2	2716	(xray (x adj ray)) same (ball bump bga)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 13:31
3	211	(solder paste) same ((xray (x adj ray)) same (ball bump bga))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 12:23
4	21	(illuminate illumination illuminating) and ((solder paste) same ((xray (x adj ray)) same (ball bump bga)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 13:32
5	190	((solder paste) same ((xray (x adj ray)) same (ball bump bga))) not ((illuminate illumination illuminating) and ((solder paste) same ((xray (x adj ray)) same (ball bump bga))))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 13:30
6	179584	(shape quadrilateral) with (pad contact terminal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 13:31
7	3600	((shape quadrilateral) with (pad contact terminal)) and (xray (x adj ray))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 13:31
8	778	((shape quadrilateral) with (pad contact terminal)) and (xray (x adj ray)) and (ball bump bga)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 13:32
9	81	(illuminate illumination illuminating) and (((shape quadrilateral) with (pad contact terminal)) and (xray (x adj ray))) and (ball bump bga)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 13:32

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2	2716	(xray (x adj ray)) same (ball bump bga)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 12:23
3	211	(solder paste) same ((xray (x adj ray)) same (ball bump bga))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 12:23
4	21	(illuminate illumination illuminating) and ((solder paste) same ((xray (x adj ray)) same (ball bump bga)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 12:43
5	190	((solder paste) same ((xray (x adj ray)) same (ball bump bga))) not ((illuminate illumination illuminating) and ((solder paste) same ((xray (x adj ray)) same (ball bump bga))))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/02/20 12:43